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(12) **United States Design Patent**
Hemmi et al.

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(54) **CONNECTOR FOR FLEXIBLE PRINTED
CIRCUIT BOARD**

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(51) **LOC (9) Cl.** **13-03**

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D13/154, 184; D14/432, 433, 436, 438;
439/64, 79, 108, 159-160, 260, 325-326,
439/329, 394-395, 607-610, 629-630, 946
See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a connector for flexible printed
circuit board, as shown and described.

DESCRIPTION

FIG. 1 is a bottom, front and left side perspective view of a
connector for flexible printed circuit board showing our new
design;

FIG. 2 is a bottom, rear and right side perspective view
thereof;

FIG. 3 is a top, front and right side perspective view thereof;

FIG. 4 is a front elevational view thereof;

FIG. 5 is a rear elevational view thereof;

FIG. 6 is a left side view thereof;

FIG. 7 is a right side view thereof.

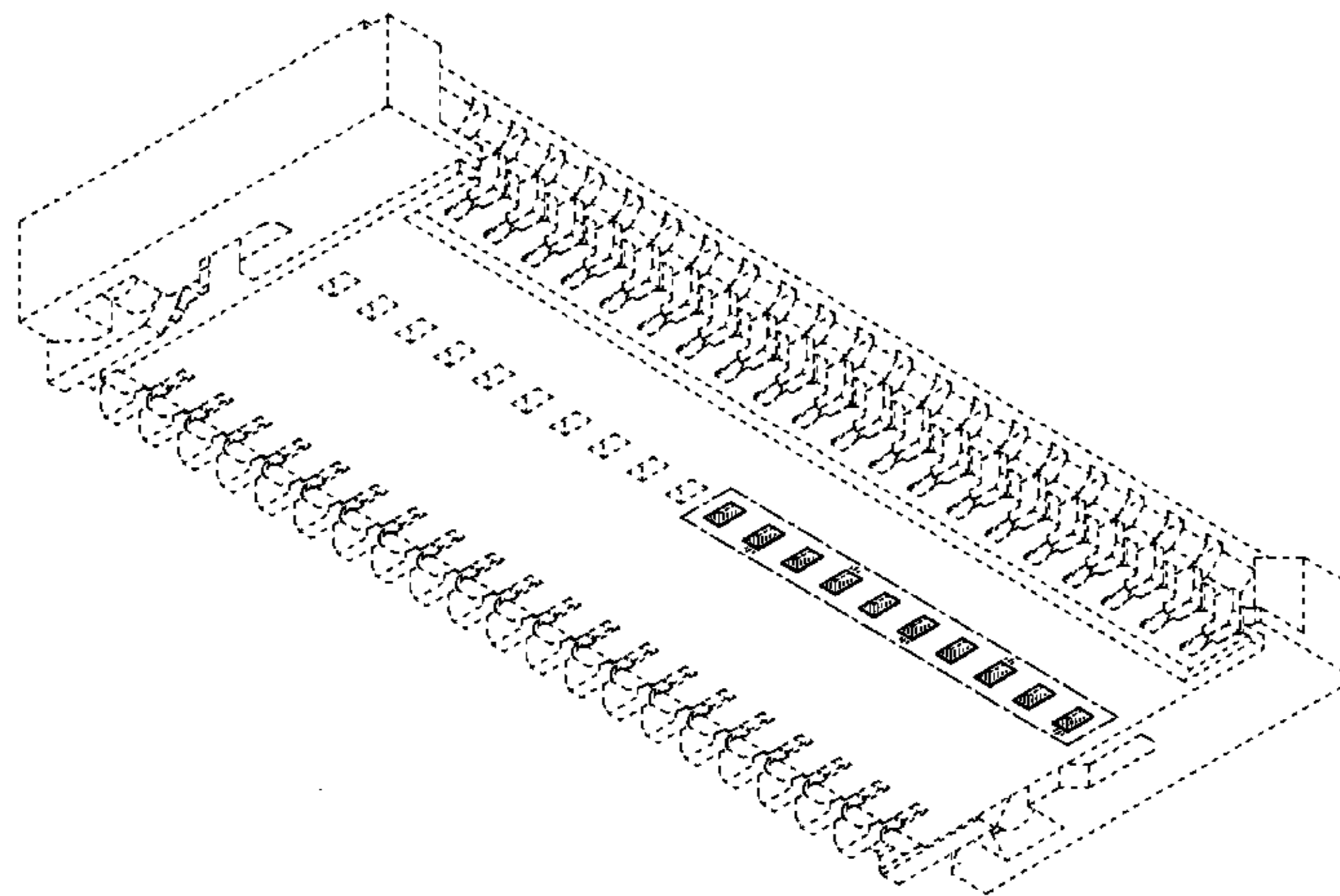
FIG. 8 is a top plan view thereof;

FIG. 9 is a bottom plan view thereof; and,

FIG. 10 is a cross-sectional view taken along the line of X—X
of FIG. 4.

The broken line portion of the figure drawings is included to
show unclaimed subject matter only and forms no part of the
claimed design.

1 Claim, 7 Drawing Sheets



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Fig. 1

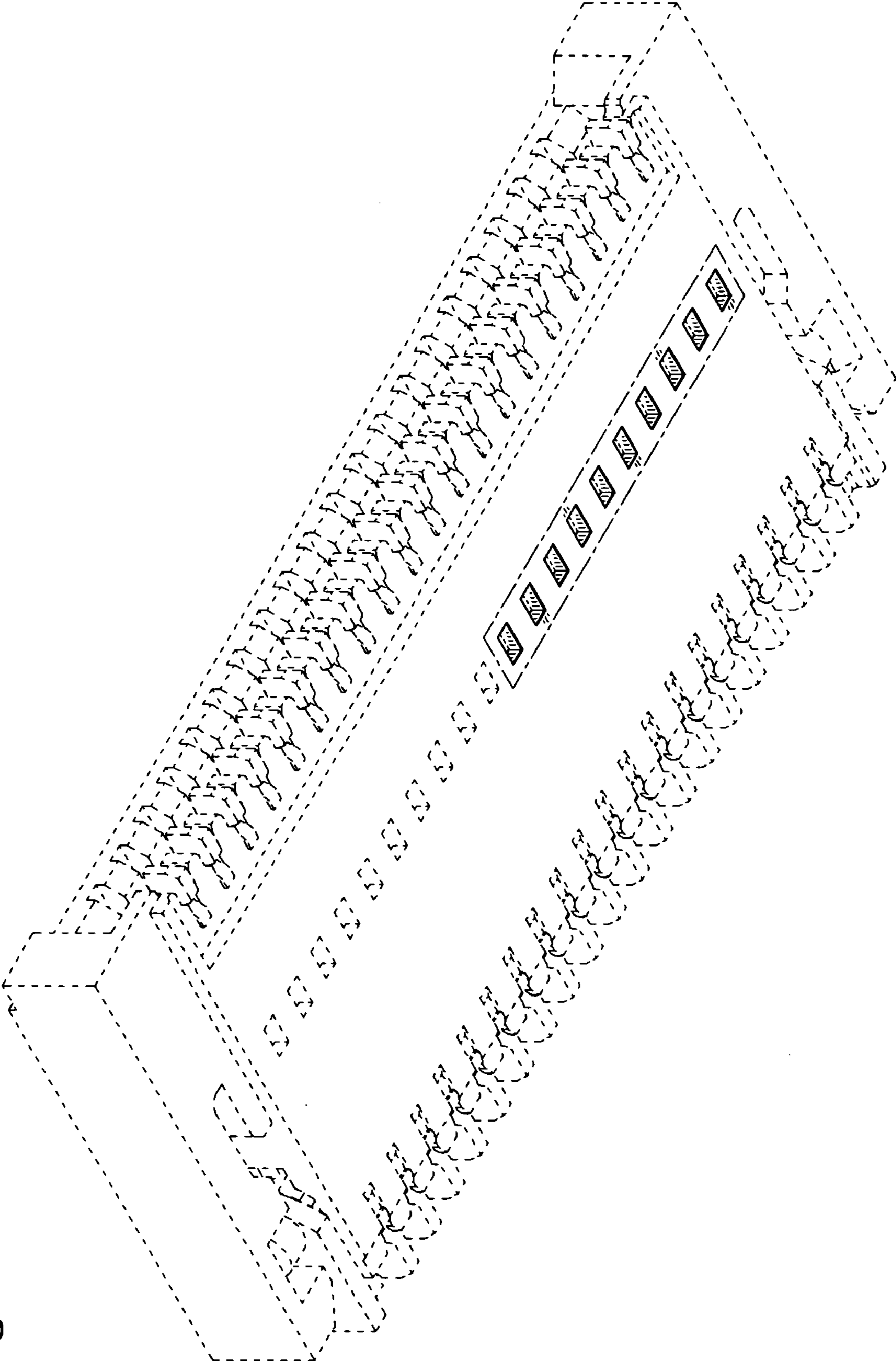


Fig. 2

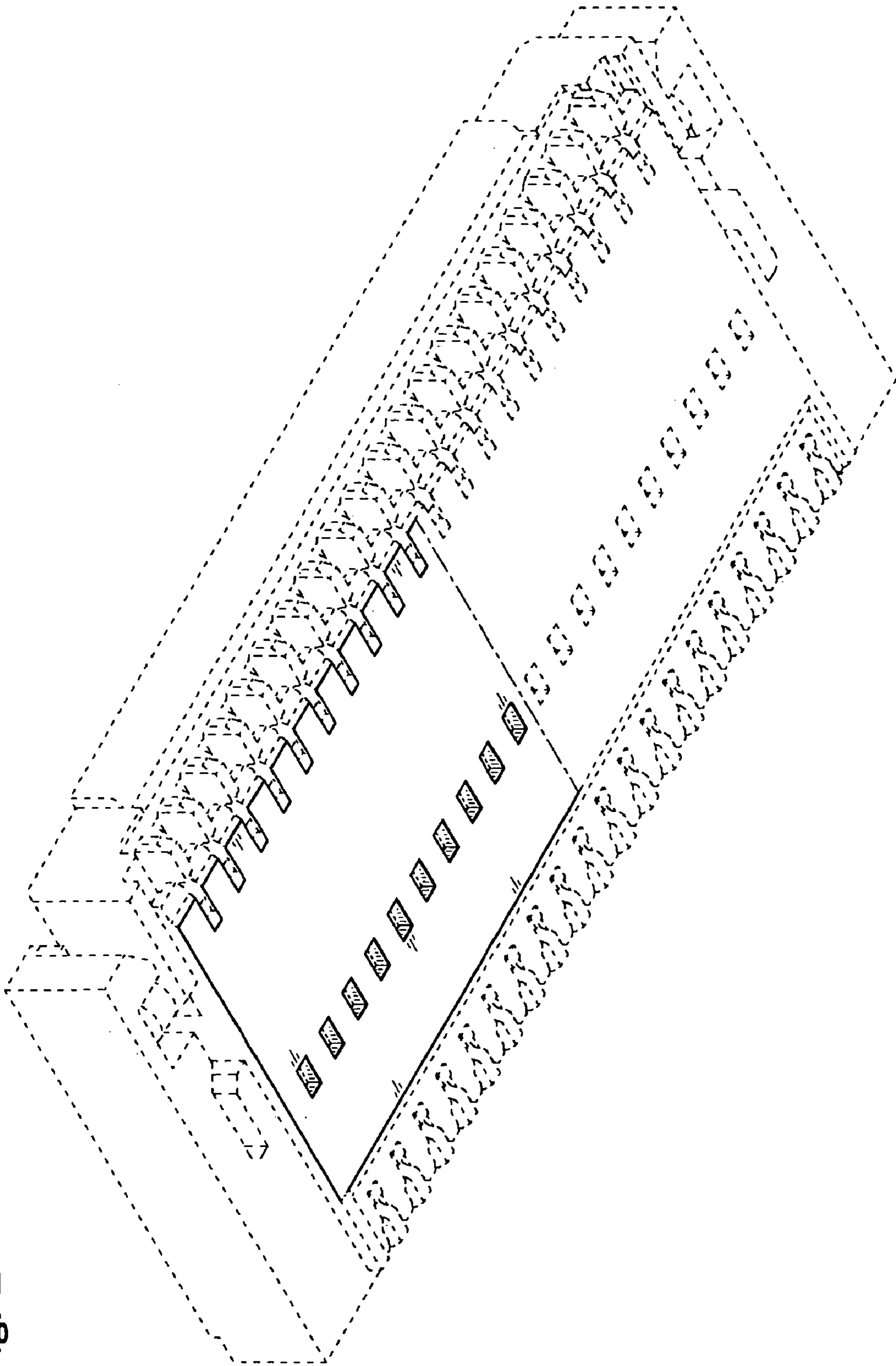


Fig. 3

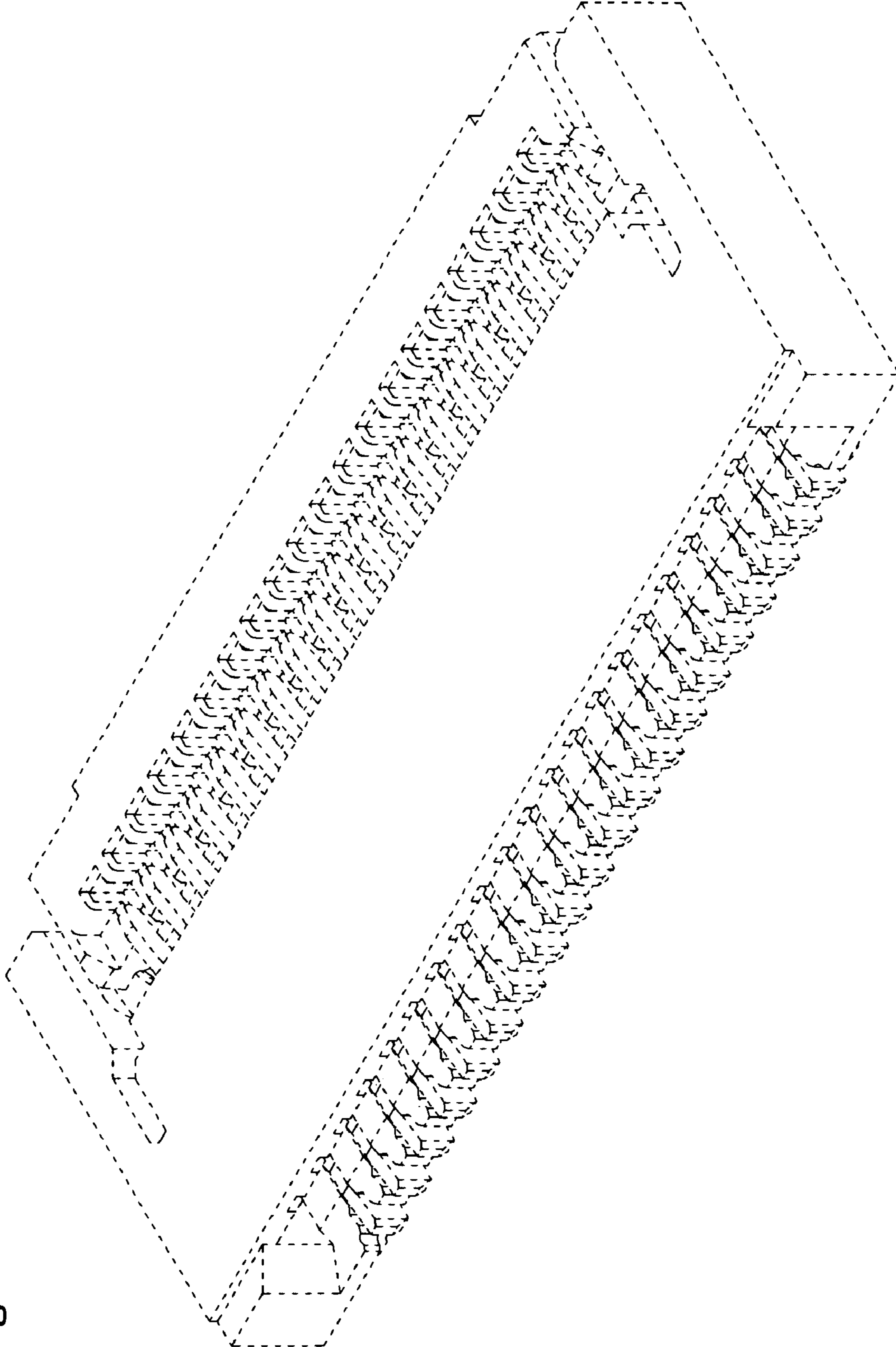


Fig. 4

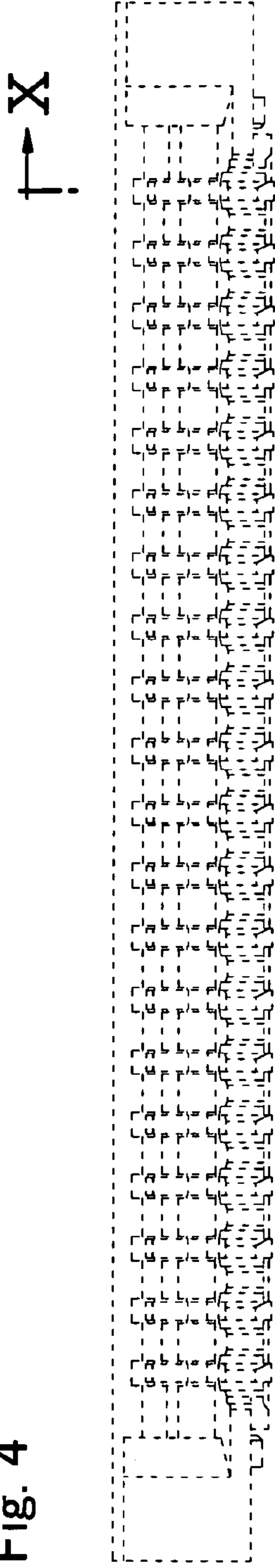


Fig. 5

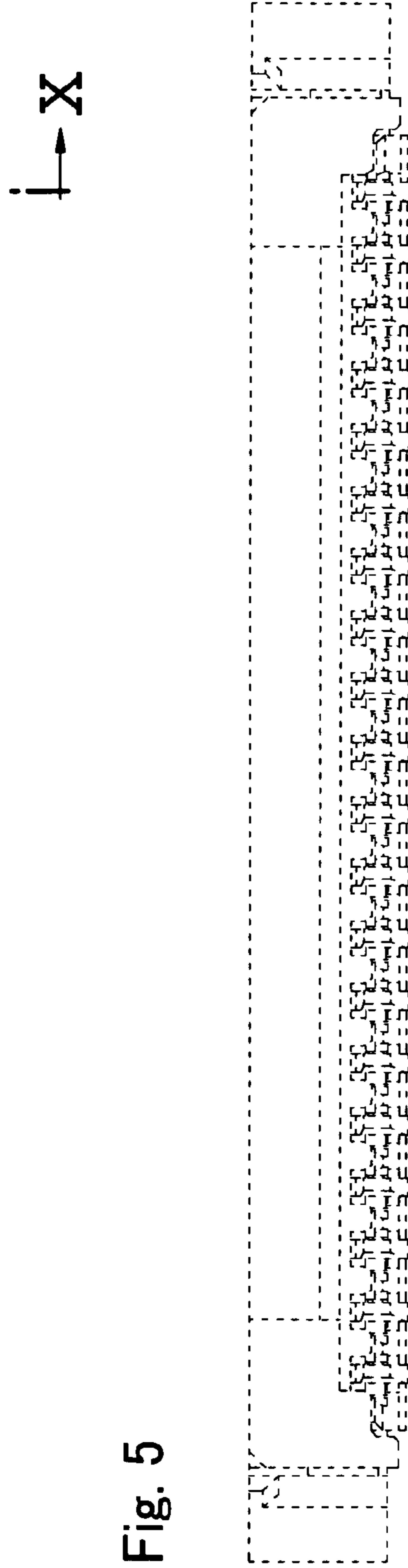
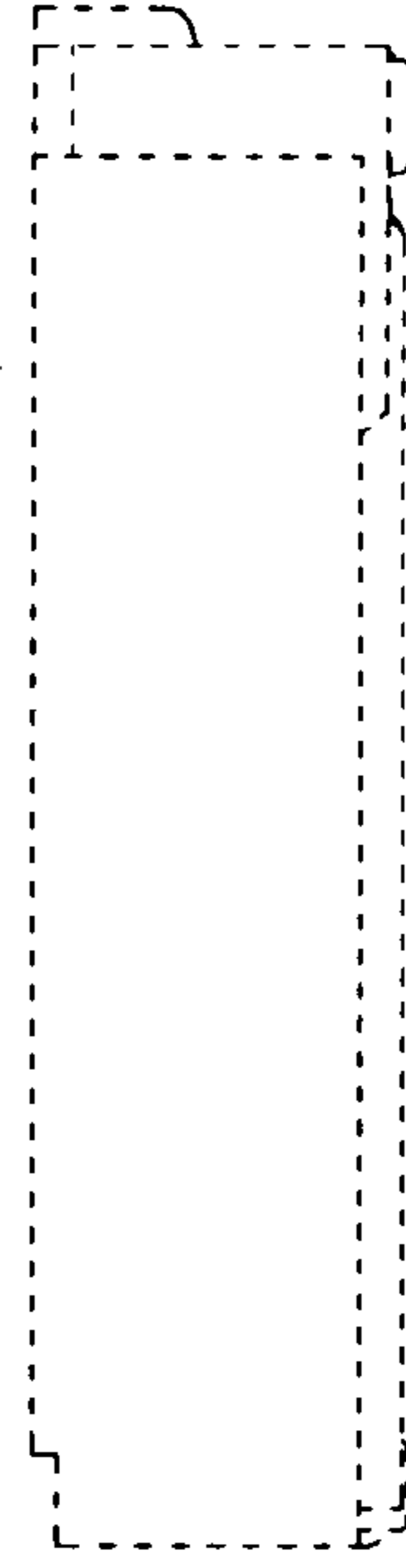


Fig. 6



Fig. 7



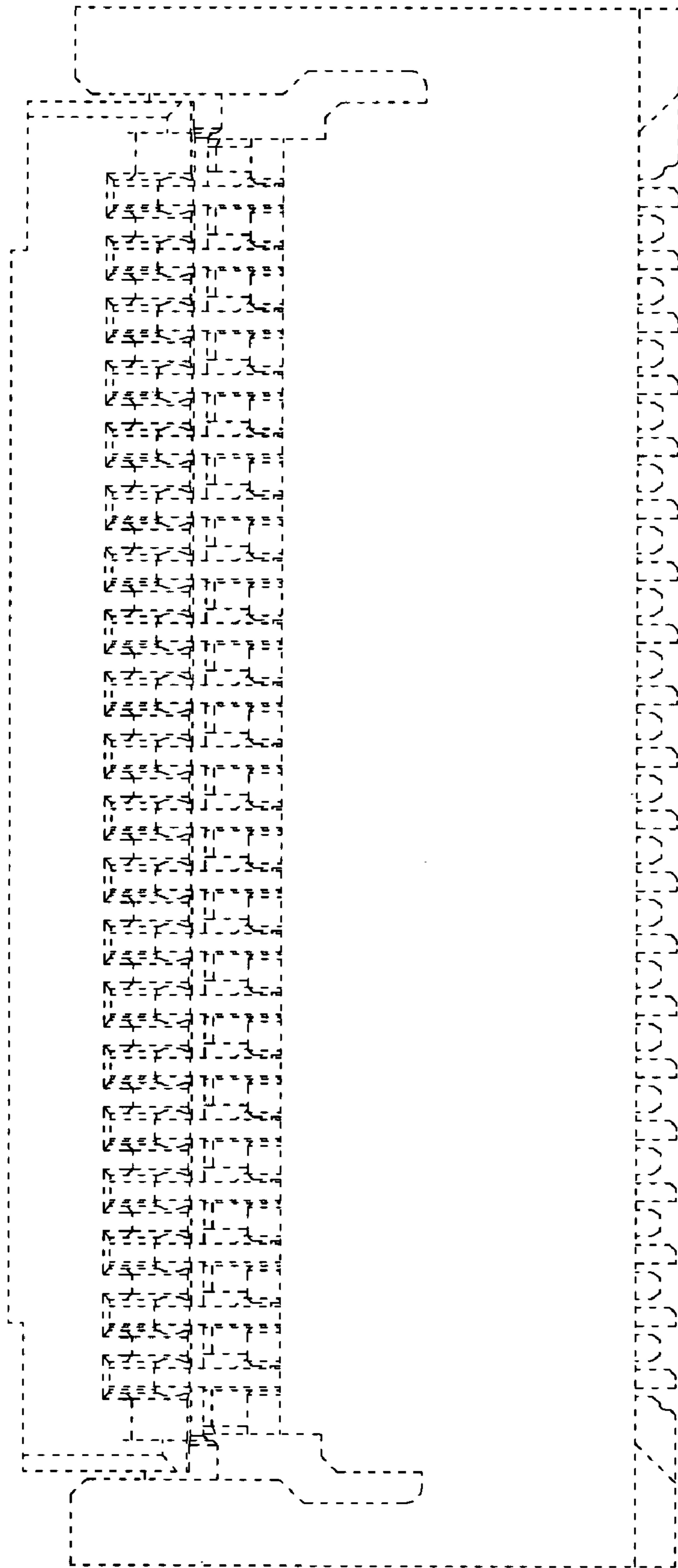


Fig. 8

Fig. 9

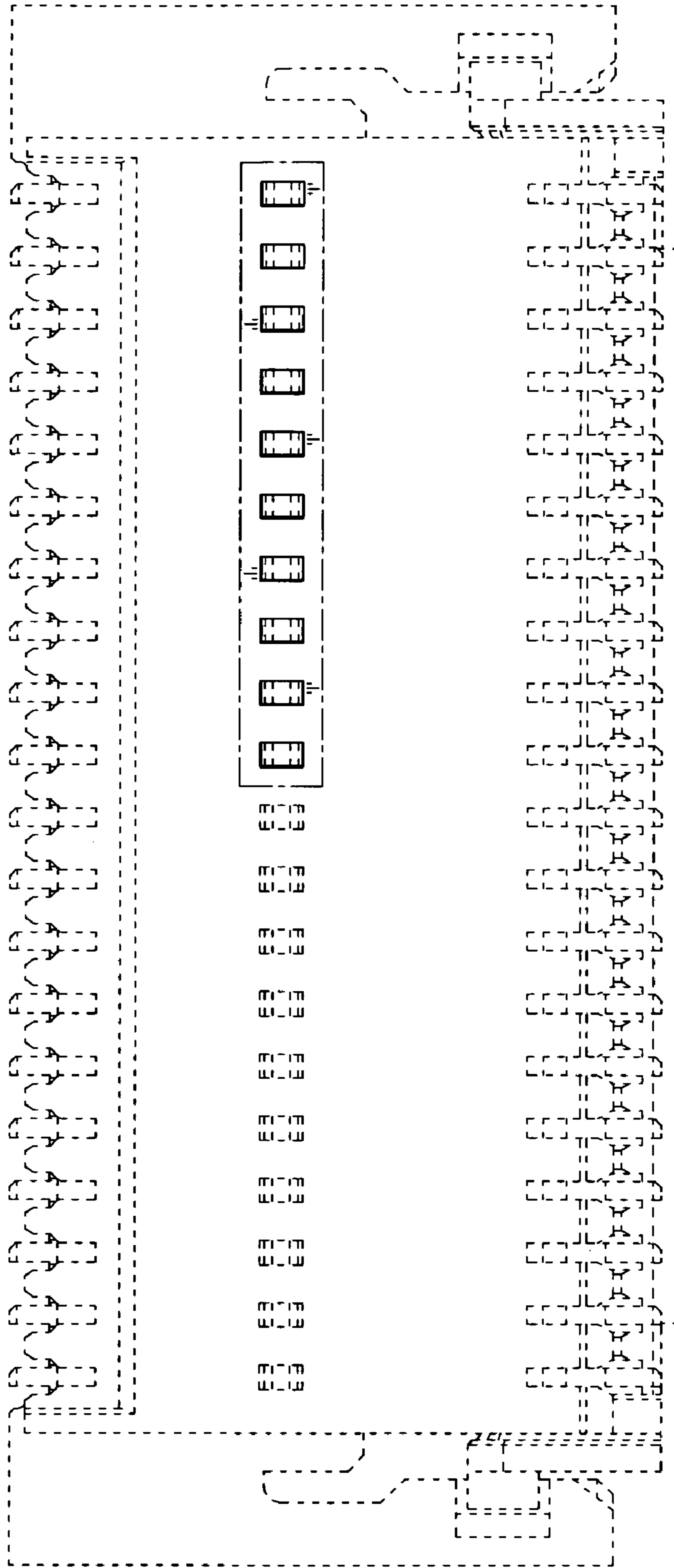


Fig. 10

